Specification for Approval

DEVICE NUMBER: BL-R4531F

• CUSTOMER:

SAMPLES ATTACHED AREA

PAGE DATE	1	2	3	4	5	6			CONTENTS
2010/6/22	1.0	1.0	1.0					4	Original Released
2015/8/11	1.1	1.1	1.1	1.1			4	A	Modify
2018/12/6	1.2	1.2	1.2	1.2	1.2	1.2			New Version
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FOR CUSTOMER'S APPROVAL STAMP OR SIGNATURE

APPROVED	PURCHASE	MANUFACTURE	QUALITY	ENGINEERING
1				

佰鴻工業股份有限公司 BRIGHT LED ELECTRONICS CORP. 新北市板橋區和平路 19 號 3 樓 3F., No.19, He Ping Road, Ban Qiao Dist., New Taipei City,

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www.brtled.com



BL-R4531F

Features:

1. Chip material: GaAsP/GaP

2. Emitted color: Red

3. Lens Appearance: Red Diffused

4. Low power consumption.

5. Most suitable for use like level indicator.

6. Excellent uniformity of light emittance.

7. Long life solid state reliability.

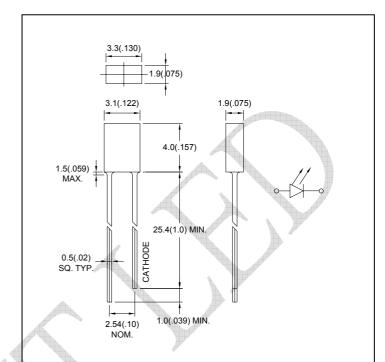
8. Compatible.

9. This product don't contained restriction substance, compliance RoHS standard.

Applications:

- 1. TV set
- 2. Monitor
- 3. Telephone
- 4. Computer
- 5. Circuit board

Package dimensions:



Notes

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25mm (0.01") unless otherwise specified.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.

● Absolute maximum ratings(Ta=25°C)

Parameter	Symbol	Rating	Unit
Power Dissipation	Pd	80	mW
Forward Current	l _F	30	mA
Peak Forward Current*1	I _{FP}	150	mA
Reverse Voltage	V_{R}	5	V
Operating Temperature	Topr	-40°℃~85°℃	
Storage Temperature	Tstg	-40℃~85℃	

^{*1}Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width.

■ Electrical and optical characteristics(Ta=25°C)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	V_{F}	I _F =20mA	-	2.1	2.6	V
Luminous Intensity	lv	I _F =20mA	-	12	-	mcd
Reverse Current	I _R	V _R =5V	-	-	100	μA
Peak Wave Length	λр	I _F =20mA	-	640	-	nm
Dominant Wave Length	λd	I _F =20mA	625	-	638	nm
Spectral Line Half-width	Δλ	I _F =20mA	-	35	-	nm
Viewing Angle	2θ _{1/2}	I _F =20mA	-	120	-	deg

Typical electro-optical characteristics curves

Fig.1 Relative intensity vs. Wavelength

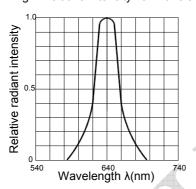


Fig.3 Forward current vs. Forward voltage

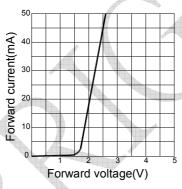


Fig.5 Relative luminous intensity

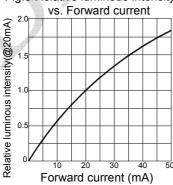


Fig.2 Forward current derating curve

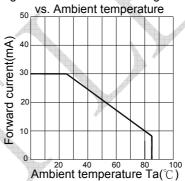


Fig.4 Relative luminous intensity

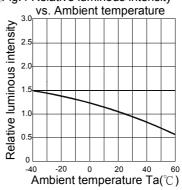
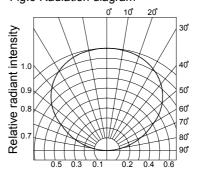


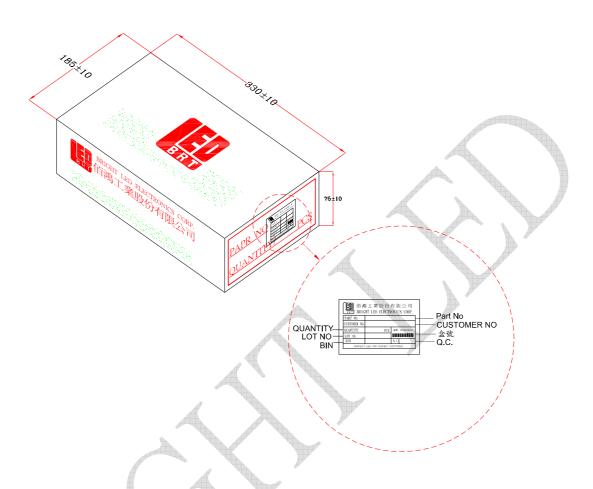
Fig.6 Radiation diagram



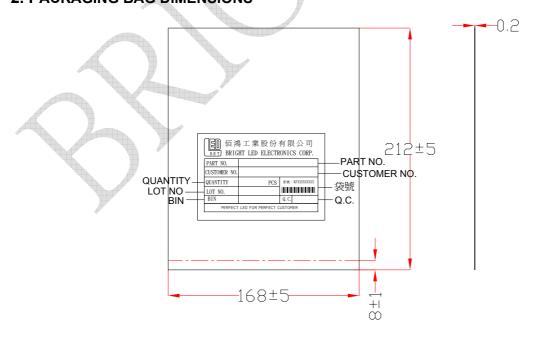
BL-R4531F

PACKAGING DIMMENSIONS

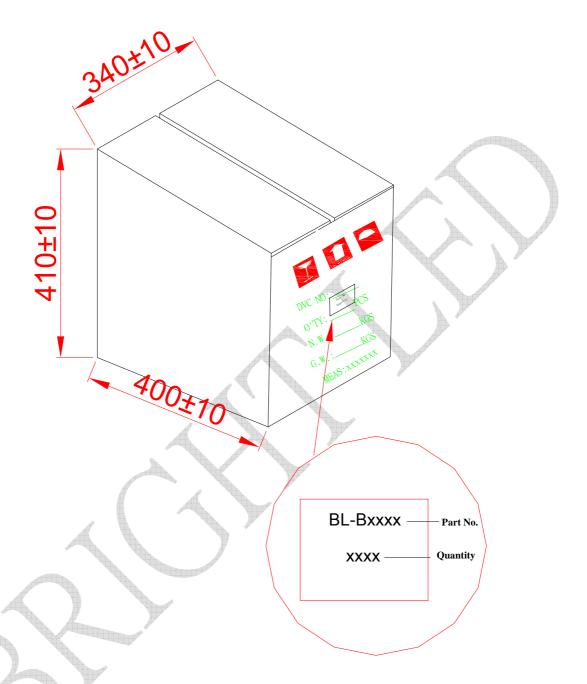
1. PACKAGING BOX DIMENSIONS:



2. PACKAGING BAG DIMENSIONS



3.PACKAGING CARTON DIMENSIONS



NOTES:

- 1. 1K PCS PER BAG, 10K PCS PER BOX, 100K PCS PER CARTON
- 2. ALL Dimensions are in millimeters (inches).
- 3. Specifications are subject to change without notice.

Reliability Test

Reliability	Test			1	
Classification	Test Item	Reference Standard	Test Conditions	Result	
	Operation Life	MIL-STD-750:1026	I _F =20mA		
		MIL-STD-883:1005	Ta=+25°C±5°C	0/32	
		JIS-C-7021 :B-1	Test time=1,000hrs		
	High		Ta=+85°C±5°C		
	Temperature	MIL-STD-202:103B	RH=90%-95%	0/32	
Endurance	High Humidity Storage	JIS-C-7021 :B-11	Test time=240hrs	0/32	
Test	High	MIL-STD-883:1008	High Ta=+85℃±5℃		
	Temperature Storage	JIS-C-7021 :B-10	Test time=1,000hrs	0/32	
	Low		Low Ta=-45°C ±5°C		
	Temperature Storage	JIS-C-7021 :B-12	Test time=1,000hrs		
	Temperature	MIL-STD-202:107D	Ta: $+85^{\circ}$ C (30min) ~ $+25^{\circ}$ C (5min) ~		
	Cycling	MIL-STD-750:1051	-45°C (30min) ~ +25°C (5min)	0/32	
		MIL-STD-883:1010	Test Time : 70min/cycle 10cycle	0/32	
		JIS-C-7021 :A-4	45°0 . 5°0 05°0 . 5°0		
	Thermal Shock	MIL-STD-202:107D	-45°C±5°C ~+85°C±5°C	0.400	
		MIL-STD-750:1051	20min 20min	0/32	
Environmental	0.11	MIL-STD-883:1011	Test Time=10cycle		
lest	Solder	MIL-STD-202:201A	Preheating : 120°C ,within 120-180 sec.		
	Resistance	MIL-STD-750:2031	Operation heating:	0/32	
		JIS-C-7021 :A-1	255°C±5°C within 5 sec.260°C (Max)		
	Solderability	MIL-STD-202F:208D	T.sol=230±5°C		
	Soluciability	MIL-STD-750D:2026	Dwell Time=5±1secs		
		MIL-STD-750D:2020	5 Wolf Time=0±15000	0/32	
		JIS C 7021:A-2			

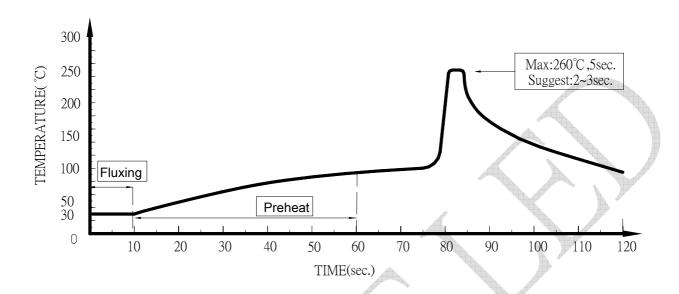
Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	V _F (V)	I _F =20mA	Over U ¹ x1.2
Reverse current	I _R (uA)	V _R =5V	Over U ¹ x2
Luminous intensity	lv (mcd)	I _F =20mA	Below S ¹ X0.5

Note: 1. U means the upper limit of specified characteristics. S means initial value.

2. Measurment shall be taken between 2 hours and after the test pieces have been returned to normal ambient conditions after completion of each test.

Dip Soldering



- Please avoid any external stress applied to the lead-frames and epoxy while the LEDs are at high temperature, especially during soldering
- 2. DIP soldering and hand soldering should not be done more than one time.
- 3. After soldering, avoid the epoxy lens from mechanical shock or vibration until the LEDs are back to room temerature.
- 4. Avoid rapid cooling during temperature ramp-down process
- 5. Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs

● IRON Soldering

A: Max: 350°C Within 3 sec. One time only.

B: For 3mm LED without flange, if the LED epoxy lays flat on the PCB, the welding condition is 350°C within 2 seconds, one time only.

3.0(.118)

PCB